

Phase Control Thyristors (Hockey-PUK Version), 2310 A



PRIMARY CHARACTERISTICS					
I _{T(AV)} 2310 A					
V_{DRM}/V_{RRM}	400 V, 600 V				
V_{TM}	1.44 V				
I _{GT}	100 mA				
T _J	-40 °C to +125 °C				
Package	K-PUK (A-24)				
Circuit configuration	Single SCR				

FEATURES

- · Center amplifying gate
- Metal case with ceramic insulator
- International standard case K-PUK (A-24)
- High profile hockey PUK
- Material categorization: for definitions of compliance please see www.vishav.com/doc?99912

Pb-free

RoHS

TYPICAL APPLICATIONS

- DC motor controls
- Controlled DC power supplies
- AC controllers

MAJOR RATINGS AND CHARACTERISTICS						
PARAMETER	TEST CONDITIONS	VALUES	UNITS			
1		2310	A			
I _{T(AV)}	T _{hs}	55	°C			
1		4150	A			
I _T (RMS)	T _{hs}	25	°C			
1	50 Hz	42 500	^			
ITSM	60 Hz	44 500	A			
l²t	50 Hz	9027	1.42-			
	60 Hz	8240	kA ² s			
V _{DRM} /V _{RRM}		400 to 600	V			
tq	Typical	200	μs			
T _J		-40 to +125	°C			

ELECTRICAL SPECIFICATIONS

VOLTAGE RATINGS								
TYPE NUMBER	VOLTAGE CODE	V _{DRM/} V _{RRM} , MAXIMUM REPETITIVE PEAK AND OFF-STATE VOLTAGE V	V _{RSM} , MAXIMUM NON-REPETITIVE PEAK VOLTAGE V	$\begin{aligned} I_{DRM} I_{RRM} & \text{MAXIMUM} \\ \text{AT } T_J &= T_J & \text{MAXIMUM} \\ & \text{mA} \end{aligned}$				
VS-ST1280CK	04	400	500	100				
VS-S11280CK 06		600	700	100				



PARAMETER	SYMBOL		TEST CONDITIONS			
Maximum average on-state current		180° condu	ction, half sine	wave	2310 (885)	Α
at heatsink temperature	I _{T(AV)}		(single side) co		55 (85)	°C
Maximum RMS on-state current	I _{T(RMS)}	25 °C heats	ink temperature	double side cooled	4150	
	· ·	t = 10 ms	No voltage		42 500	A kA ² s
Maximum peak, one-cycle		t = 8.3 ms	reapplied		44 500	
non-repetitive surge current	I _{TSM}	t = 10 ms	100 % V _{RRM}		35 700	
		t = 8.3 ms	reapplied	Sinusoidal half wave, initial $T_J = T_J$ maximum	37 400	
Maximum I ² t for fusing	I ² t	t = 10 ms	No voltage reapplied		9027	
		t = 8.3 ms			8241	
		t = 10 ms			6383	
		t = 8.3 ms	reapplied		5828	
Maximum I ² √t for fusing	I ² √t	t = 0.1 to 10	ms, no voltage	reapplied	90 270	kA²√s
Low level value of threshold voltage	V _{T(TO)1}	(16.7 % x π	$x I_{T(AV)} < I < \pi x$	$I_{T(AV)}$), $T_J = T_J$ maximum	0.83	V
High level value of threshold voltage	V _{T(TO)2}	$(I > \pi \times I_{T(AV)})$	$(I > \pi \times I_{T(AV)}), T_J = T_J \text{ maximum}$]
Low level value of on-state slope resistance	r _{t1}	(16.7 % x π x $I_{T(AV)}$ < I < π x $I_{T(AV)}$), $T_J = T_J$ maximum			0.077	mΩ
High level value of on-state slope resistance	r _{t2}	$(I > \pi \times I_{T(AV)}), T_J = T_J \text{ maximum}$			0.068	11152
Maximum on-state voltage	V_{TM}	$I_{pk} = 8000 \text{ A}, T_J = T_J \text{ maximum}, t_p = 10 \text{ ms sine pulse}$			1.44	V
Maximum holding current	I _H	T. = 25 °C	T 05 00 and a set 40 V set to be d			mA
Typical latching current	IL	T _J = 25 °C, anode supply 12 V resistive load			1000	IIIA

SWITCHING						
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS		
Maximum non-repetitive rate of rise of turned-on current	dl/dt	Gate drive 20 V, 20 Ω , $t_r \le 1~\mu s$ $T_J = T_J$ maximum, anode voltage $\le 80~\%~V_{DRM}$	1000	A/µs		
Typical delay time	t _d	Gate current 1 A, $dl_g/dt = 1 A/\mu s$ $V_d = 0.67 \% V_{DRM}, T_J = 25 °C$	1.9			
Typical turn-off time	t _q	I_{TM} = 550 A, T_J = T_J maximum, dl/dt = 40 A/μs, V_R = 50 V, dV/dt = 20 V/μs, gate 0 V 100 Ω , t_p = 500 μs	200	μs		

BLOCKING						
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS		
Maximum critical rate of rise of off-state voltage	dV/dt	T _J = T _J maximum linear to 80 % rated V _{DRM}	500	V/µs		
Maximum peak reverse and off-state leakage current	I _{RRM} , I _{DRM}	$T_J = T_J$ maximum, rated V_{DRM}/V_{RRM} applied	100	mA		



TRIGGERING						
PARAMETER	SYMBOL	TEST CONDITIONS			VALUES	
PANAMETEN	STWIDOL	16	1E31 CONDITIONS			UNITS
Maximum peak gate power	P _{GM}	$T_J = T_J$ maximum,	$t_p \leq 5 \ ms$	16		W
Maximum average gate power	P _{G(AV)}	$T_J = T_J$ maximum,	f = 50 Hz, d% = 50	;	3] ^{vv}
Maximum peak positive gate current	I _{GM}			3	.0	Α
Maximum peak positive gate voltage	+ V _{GM}	$T_J = T_J$ maximum,	$T_J = T_J$ maximum, $t_p \le 5$ ms		.0	V
Maximum peak negative gate voltage	- V _{GM}				.0]
	I _{GT}	T _J = -40 °C	Maximum required gate trigger/- current/voltage are the lowest	200	-	
DC gate current required to trigger		T _J = 25 °C		100	200	mA
		T _J = 125 °C		50	-	
		T _J = -40 °C	value which will trigger all units	1.4	-	
DC gate voltage required to trigger	V_{GT}	T _J = 25 °C	T _J = 25 °C 12 V anode to cathode applied	1.1	3.0	V
		T _J = 125 °C		0.9	-	1
DC gate current not to trigger	I _{GD}		Maximum gate current/voltage	1	0	mA
DC gate voltage not to trigger	V _{GD}	$T_J = T_J \text{ maximum}$	not to trigger is the maximum value which will not trigger any unit with rated V _{DRM} anode to cathode applied	0.25		V

THERMAL AND MECHANICAL SPECIFICATIONS					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Maximum operating temperature range	TJ		-40 to 125	°C	
Maximum storage temperature range	T _{Stg}		-40 to 150		
Maximum thermal resistance, junction to	Б	DC operation single side cooled	0.042		
heatsink	R _{thJ-hs}	DC operation double side cooled	0.021	14.004	
Maximum thousand variations against a hostainly	R _{thC-hs}	DC operation single side cooled	0.006	K/W	
Maximum thermal resistance, case to heatsink		DC operation double side cooled	0.003]	
Mounting force, ± 10 %			24 500 (2500)	N (kg)	
Approximate weight			425	g	
Case style		See dimensions - link at the end of datasheet	K-PUK (A	A-24)	

△R _{thJC} CONDUCTION							
CONDUCTION ANGLE	SINUSOIDAL	CONDUCTION	RECTANGULAR	RCONDUCTION	TEST CONDITIONS	UNITS	
CONDUCTION ANGLE	SINGLE SIDE	DOUBLE SIDE	SINGLE SIDE	DOUBLE SIDE	TEST CONDITIONS	UNIIS	
180°	0.003	0.003	0.002	0.002	$T_J = T_J$ maximum		
120°	0.004	0.004	0.004	0.004			
90°	0.005	0.005	0.005	0.005		K/W	
60°	0.007	0.007	0.007	0.007			
30°	0.012	0.012	0.012	0.012			

Note

• The table above shows the increment of thermal resistance R_{thJC} when devices operate at different conduction angles than DC

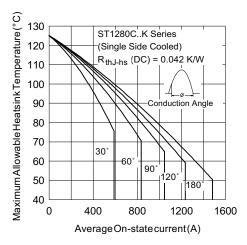


Fig. 1 - Current Ratings Characteristics

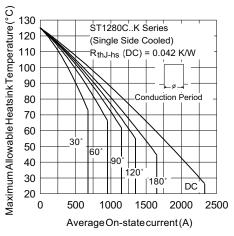


Fig. 2 - Current Ratings Characteristics

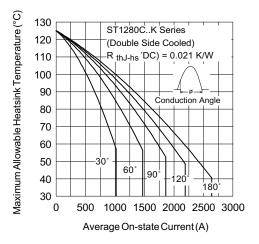


Fig. 3 - Current Ratings Characteristics

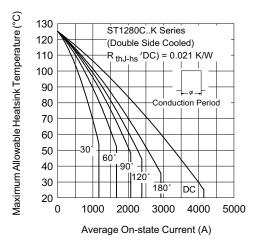


Fig. 4 - Current Ratings Characteristics

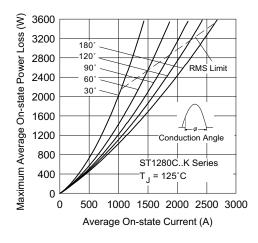


Fig. 5 - On-State Power Loss Characteristics

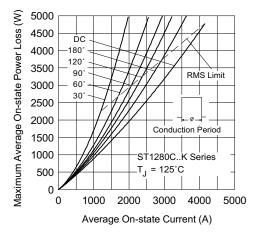
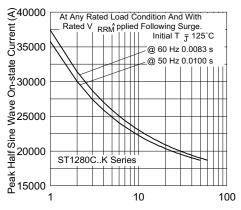


Fig. 6 - On-State Power Loss Characteristics



Number Of Equal Amplitude Half Cycle Current Pulses (N)

Fig. 7 - Maximum Non-Repetitive Surge Current Single and Double Side Cooled

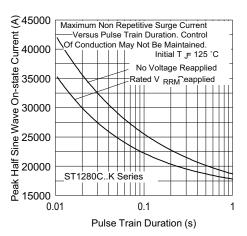


Fig. 8 - Maximum Non-Repetitive Surge Current Single and Double Side Cooled

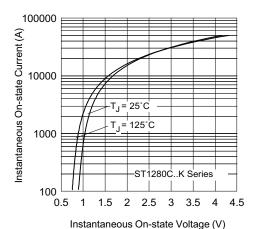


Fig. 9 - On-State Voltage Drop Characteristics

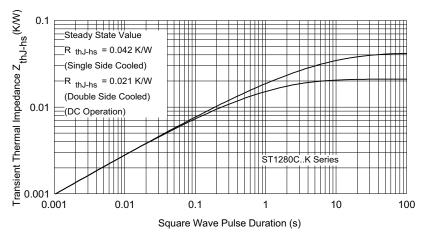


Fig. 10 - Thermal Impedance Z_{thJ-hs} Characteristics

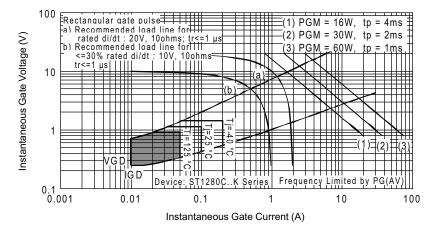
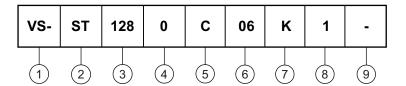


Fig. 11 - Gate Characteristics

ORDERING INFORMATION TABLE

Device code



1 - Vishay Semiconductors product

2 - Thyristor

- Essential part number

4 - 0 = converter grade

5 - C = ceramic PUK

6 - Voltage code x 100 = V_{RRM} (see Voltage Ratings table)

7 - K = PUK case K-PUK (A-24)

8 - 0 = eyelet terminals (gate and auxiliary cathode unsoldered leads)

1 = fast-on terminals (gate and auxiliary cathode unsoldered leads)

2 = eyelet terminals (gate and auxiliary cathode soldered leads)

3 = fast-on terminals (gate and auxiliary cathode soldered leads)

9 - Critical dV/dt: • none = 500 V/µs (standard selection)

• L = 1000 V/µs (special selection)

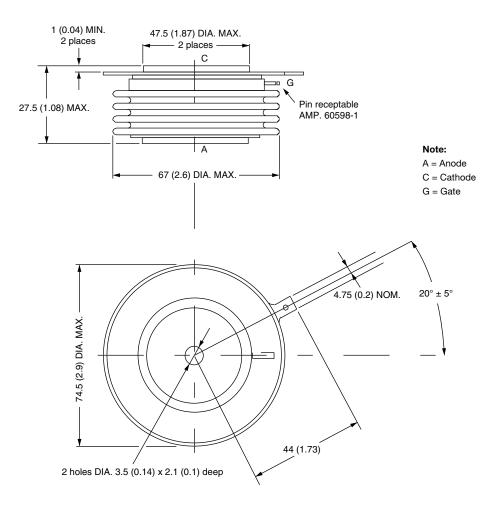
LINKS TO RELATED DOCUMENTS				
Dimensions	www.vishay.com/doc?95081			



K-PUK (A-24)

DIMENSIONS in millimeters (inches)

Creepage distance: 28.88 (1.137) minimum Strike distance: 17.99 (0.708) minimum



Quote between upper and lower pole pieces has to be considered after application of mounting force (see thermal and mechanical specification)



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